



GP
ELECTRONICS

GPT010N04LTPa
40V N-Channel MOSFET

Product Summary

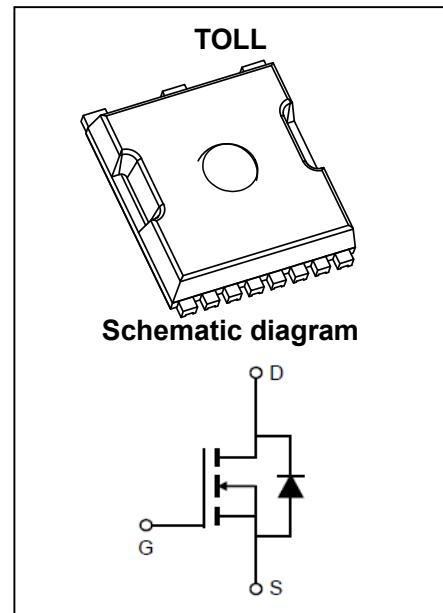
$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
40V	1.3mΩ@10V	250A
	2.0mΩ@4.5V	

Feature

- Trench Technology Power MOSFET
- Low $R_{DS(ON)}$
- Low Gate Charge
- Low Gate Resistance
- 100% UIS Tested

Application

- Power Switching Application



MARKING:



T010N04L = Device Code

XX = Date Code

Solid Dot = Green Indicator

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

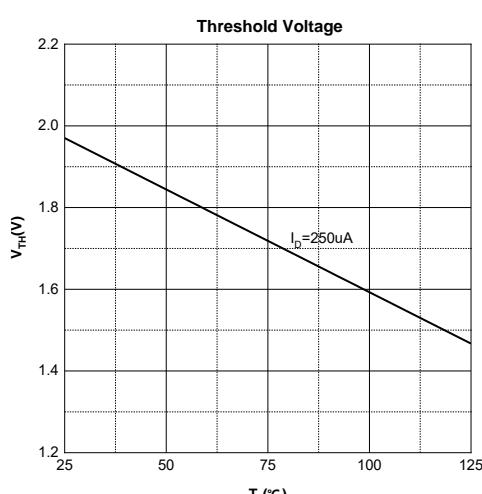
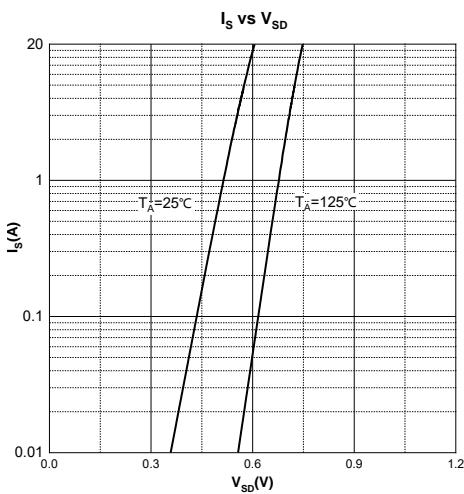
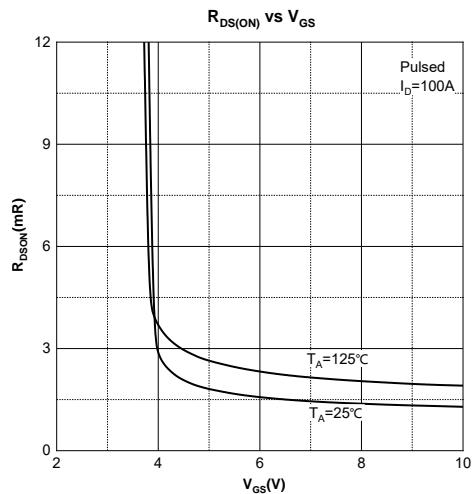
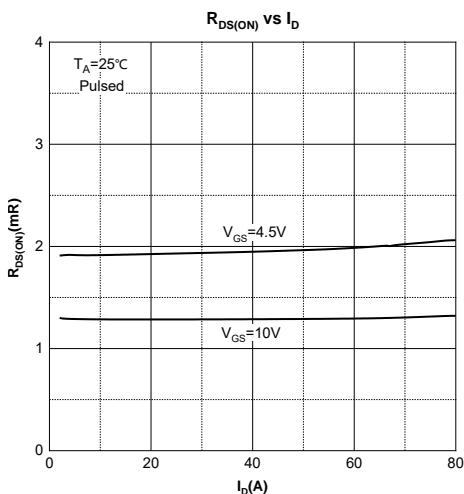
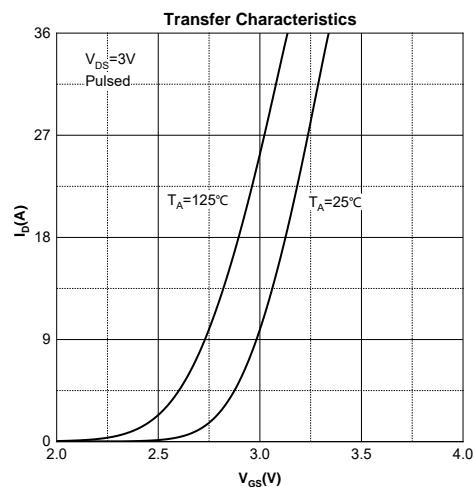
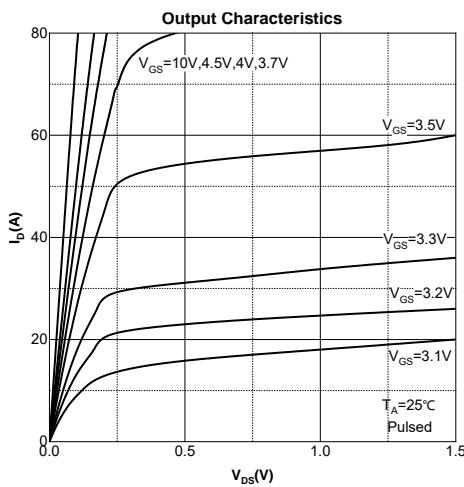
Parameter	Symbol	Value	Unit
Drain - Source Voltage	V_{DS}	40	V
Gate - Source Voltage	V_{GS}	± 20	V
Continuous Drain Current ¹	I_D	250	A
	I_D	163	A
Pulsed Drain Current ²	I_{DM}	1000	A
Single Pulsed Avalanche Current ³	I_{AS}	65	A
Single Pulsed Avalanche Energy ³	E_{AS}	1056	mJ
Power Dissipation ⁵	P_D	250	W
Thermal Resistance from Junction to Ambient ⁶	$R_{\theta JA}$	45	°C/W
Thermal Resistance from Junction to Case	$R_{\theta JC}$	0.5	°C/W
Junction Temperature	T_J	150	°C
Storage Temperature	T_{STG}	-55~+150	°C

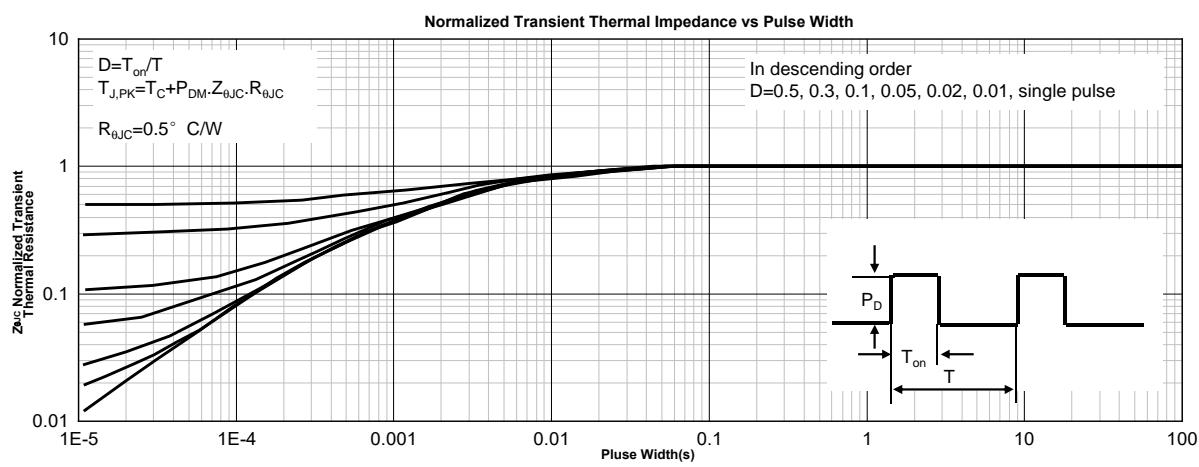
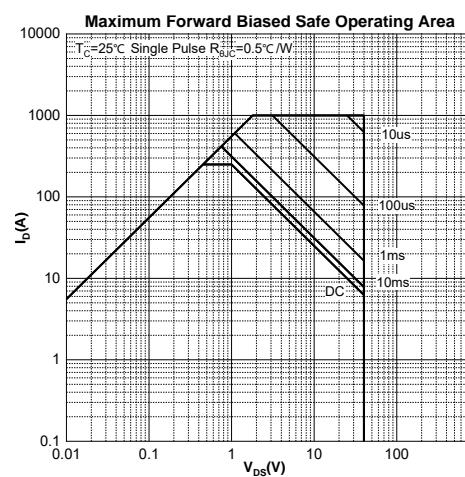
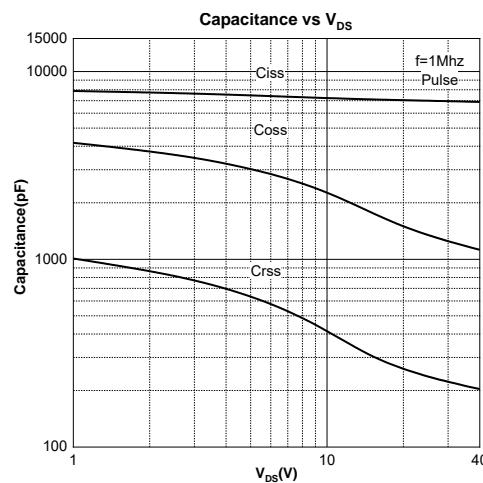
MOSFET ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$ unless otherwise noted)

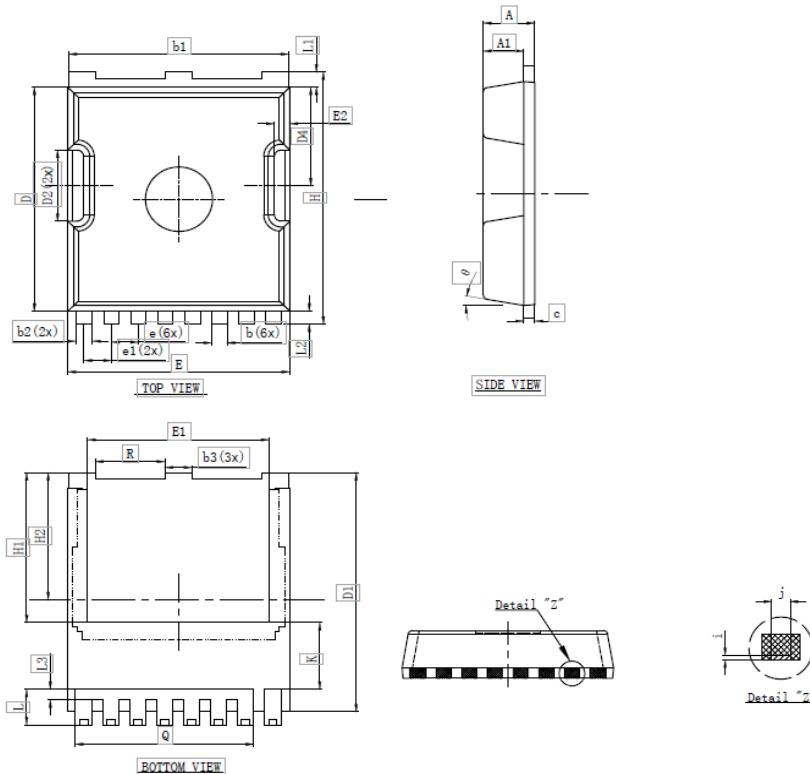
Parameter	Symbol	Test Condition	Min	Type	Max	Unit
Off Characteristics						
Drain - Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	40			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}} = 40\text{V}, V_{\text{GS}} = 0\text{V}$			1	μA
Gate - Body Leakage Current	I_{GSS}	$V_{\text{GS}} = \pm 20\text{V}, V_{\text{DS}} = 0\text{V}$			± 100	nA
On Characteristics⁴						
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$	1	2	3	V
Drain-source On-resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 10\text{V}, I_D = 20\text{A}$		1.3	1.7	$\text{m}\Omega$
		$V_{\text{GS}} = 4.5\text{V}, I_D = 20\text{A}$		2.0	3.0	
Dynamic Characteristics						
Input Capacitance	C_{iss}	$V_{\text{DS}} = 20\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		6985		pF
Output Capacitance	C_{oss}			1534		
Reverse Transfer Capacitance	C_{rss}			252		
Gate Resistance	R_g	$V_{\text{DS}} = 0\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		2.9		Ω
Switching Characteristics						
Total Gate Charge	Q_g	$V_{\text{DS}} = 20\text{V}, V_{\text{GS}} = 10\text{V}, I_D = 10\text{A}$		104		nC
Gate-source Charge	Q_{gs}			19		
Gate-drain Charge	Q_{gd}			16		
Turn-on Delay Time	$t_{d(\text{on})}$	$V_{\text{DD}} = 20\text{V}, V_{\text{GS}} = 10\text{V}, I_D = 50\text{A}, R_G = 4\Omega$		15		ns
Turn-on Rise Time	t_r			8		
Turn-off Delay Time	$t_{d(\text{off})}$			58		
Turn-off Fall Time	t_f			10		
Source - Drain Diode Characteristics						
Diode Forward Voltage ⁴	V_{SD}	$V_{\text{GS}} = 0\text{V}, I_s = 10\text{A}$			1.2	V

Notes :

- 1.The maximum current rating is limited by package.And device mounted on a large heatsink
- 2.Pulse Test : Pulse Width $\leq 10\mu\text{s}$, duty cycle $\leq 1\%$.
- 3.E_{AS} condition: $V_{\text{DD}} = 28\text{V}, V_{\text{GS}} = 10\text{V}, L = 0.5\text{mH}, R_G = 25\Omega$ Starting $T_J = 25^\circ\text{C}$.
- 4.Pulse Test : Pulse Width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.
- 5.The power dissipation P_D is limited by $T_{J(\text{MAX})} = 150^\circ\text{C}$.And device mounted on a large heatsink
- 6.Device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^\circ\text{C}$.

Typical Characteristics




TOLL Package Information


SYMBOL	MILLIMETER		Dimensions In Inches	
	MIN.	MAX.	Min.	Max.
A	2.200	2.400	0.087	0.094
A1	1.700	1.900	0.067	0.075
b	0.600	0.800	0.024	0.031
b1	9.700	9.900	0.382	0.390
b2	0.650	0.850	0.026	0.033
b3	1.100	1.300	0.043	0.051
c	0.400	0.600	0.016	0.024
D	10.300	10.500	0.406	0.413
D1	11.000	11.200	0.433	0.441
D2	3.200	3.400	0.126	0.134
D4	4.470	4.670	0.176	0.184
E	9.800	10.000	0.386	0.394
E1	8.000	8.200	0.315	0.323
E2	0.500	0.700	0.020	0.028
e	1.200 BSC		0.047BSC	
e1	1.225 BSC		0.048BSC	
H	11.600	11.800	0.457	0.465
H1	6.950 BSC		0.247BSC	
H2	5.900 BSC		0.232BSC	
i	0.100 REF		0.004REF	
j	0.350 REF		0.014REF	
K	3.100 REF		0.122REF	
L	1.550	1.750	0.061	0.069
L1	0.600	0.800	0.024	0.031
L2	0.500	0.700	0.020	0.028
L3	0.400	0.600	0.016	0.024
Q	7.950 REF		0.313REF	
R	3.000	3.200	0.118	0.126
θ	10°			